



## SSCU78P100GT4

### N-Channel Enhancement Mode MOSFET

#### ➤ Features

V <sub>DS</sub>	V <sub>GS</sub>	R <sub>DS(ON)</sub> Typ.	I <sub>D</sub>
-100V	±20V	78mΩ@-10V	-36A
		84mΩ@-4.5V	

#### ➤ Description

This device is P-Channel enhancement MOSFET. Uses trench technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit.

**100% UIS + ΔVDS + Rg Tested!**

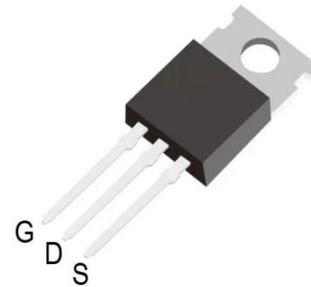
#### ➤ Applications

- Load Switch
- PWM Application
- Power Management
- DC-DC Conversion

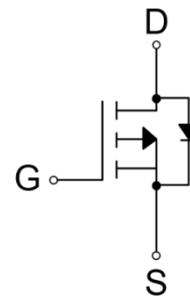
#### ➤ Ordering Information

Device	Package	Shipping
SSCU78P100GT4	TO-220-3L	50/Tube

#### ➤ Pin configuration



**TO-220-3L (Top View)**



**Pin Configuration**



**Marking**

(XYYY: Internal Traceability Code)



## ➤ Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V <sub>DSS</sub>	Drain-to-Source Voltage	-100	V
V <sub>GSS</sub>	Gate-to-Source Voltage	±20	V
I <sub>D</sub>	Continuous Drain Current <sup>d</sup>	T <sub>C</sub> =25°C	-36
		T <sub>C</sub> =100°C	-18
I <sub>DSM</sub>	Continuous Drain Current <sup>a</sup>	T <sub>A</sub> =25°C	-4.5
		T <sub>A</sub> =70°C	-3.2
I <sub>DM</sub>	Pulsed Drain Current <sup>b</sup>	-145	A
P <sub>D</sub>	Power Dissipation <sup>c</sup>	T <sub>C</sub> =25°C	148
		T <sub>C</sub> =100°C	60
P <sub>DSM</sub>	Power Dissipation <sup>a</sup>	T <sub>A</sub> =25°C	2.5
		T <sub>A</sub> =70°C	1.6
I <sub>AS</sub>	Avalanche Current <sup>b</sup> L=0.5mH Single Pulse	-20	A
E <sub>AS</sub>	Avalanche Energy <sup>b</sup> L=0.5mH Single Pulse	100	mJ
T <sub>J</sub>	Operation junction temperature	-55~150	°C
T <sub>STG</sub>	Storage temperature range	-55~150	

## ➤ Thermal Resistance Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
R <sub>θJA</sub>	Junction-to-Ambient Thermal Resistance <sup>a</sup>	50	°C/W
R <sub>θJC</sub>	Junction-to-Case Thermal Resistance	0.85	

Note:

- The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.copper, in a still air environment with T<sub>A</sub>=25°C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The power dissipation P<sub>D</sub> is based on T<sub>J(MAX)</sub>=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- The maximum current rating is package limited.



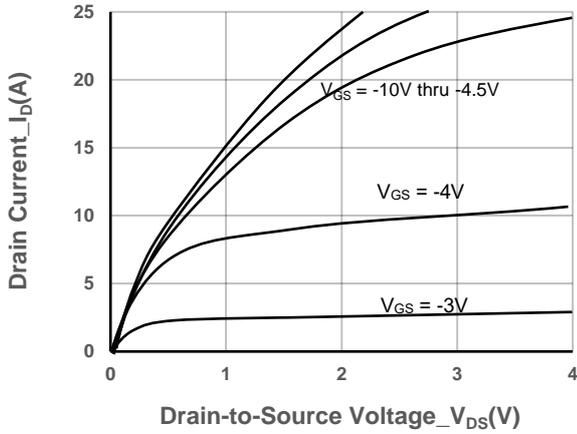
# SSCU78P100GT4

➤ **Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)**

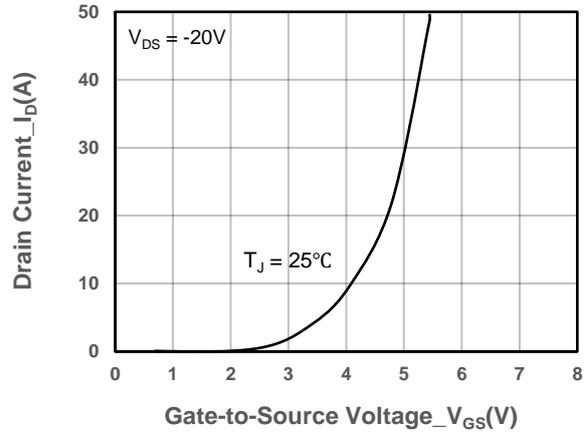
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-100			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250uA	-1.1	-1.6	-2.5	V
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10V, I <sub>D</sub> = -20A		78	105	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -10A		84	135	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -100V, V <sub>GS</sub> = 0V			-1	μA
Gate-Source Leak Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±100	nA
Transconductance	G <sub>FS</sub>	V <sub>DS</sub> = -10V, I <sub>D</sub> = -10A		25		S
Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = -10A		-0.7	-1.3	V
Gate Resistance	R <sub>G</sub>	V <sub>DS</sub> = 0V, f = 1MHz		6.5		Ω
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V, f = 1MHz		3210		pF
Output Capacitance	C <sub>OSS</sub>			120		
Reverse Transfer Capacitance	C <sub>RSS</sub>			116		
Total Gate Charge	Q <sub>G</sub>	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -50V, I <sub>D</sub> = -20A		49		nC
Gate to Source Charge	Q <sub>GS</sub>			8.5		
Gate to Drain Charge	Q <sub>GD</sub>			6		
Turn-on Delay Time	T <sub>D(ON)</sub>	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -30V, I <sub>D</sub> = -10A, R <sub>G</sub> = 30Ω,		12		ns
Rise Time	T <sub>r</sub>			26		
Turn-off Delay Time	T <sub>D(OFF)</sub>			78		
Fall Time	T <sub>f</sub>			50		



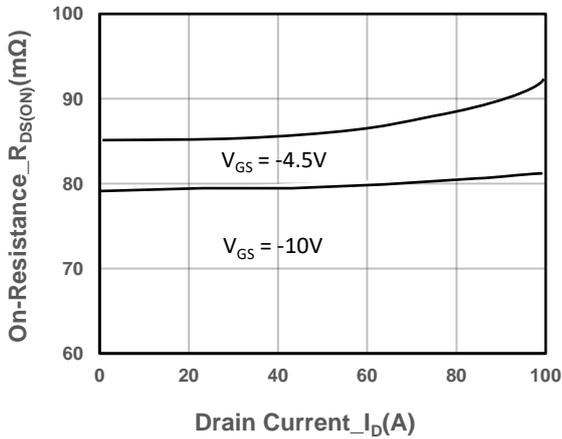
➤ **Typical Performance Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise noted)**



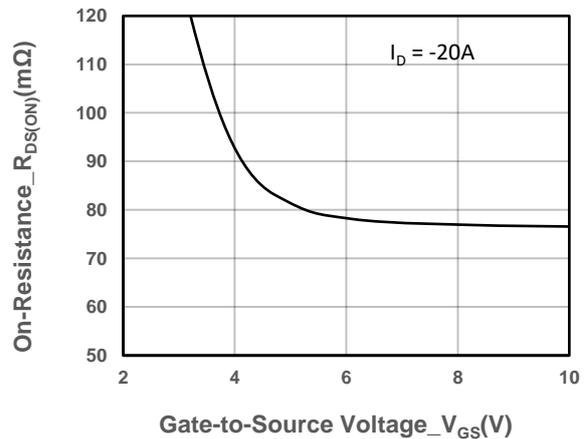
**Output Characteristics**



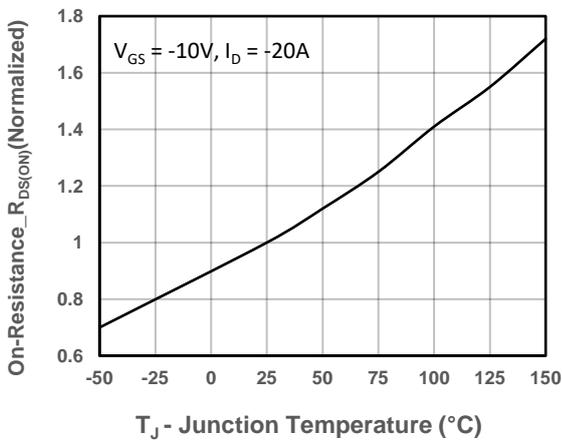
**Transfer Characteristics**



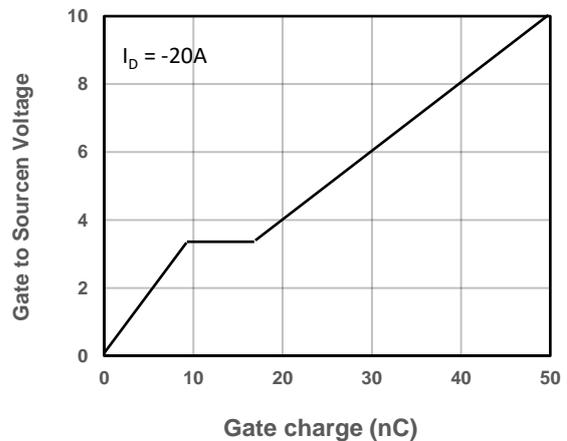
**On-Resistance vs. Drain Current and Gate Voltage**



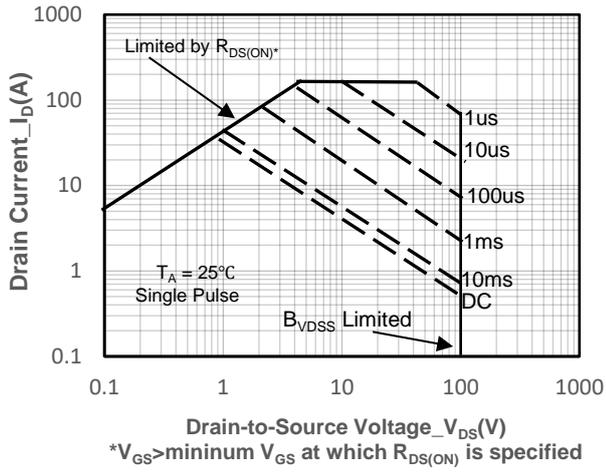
**On-Resistance vs. Gate-to-Source Voltage**



**On-Resistance vs. Junction Temperature**



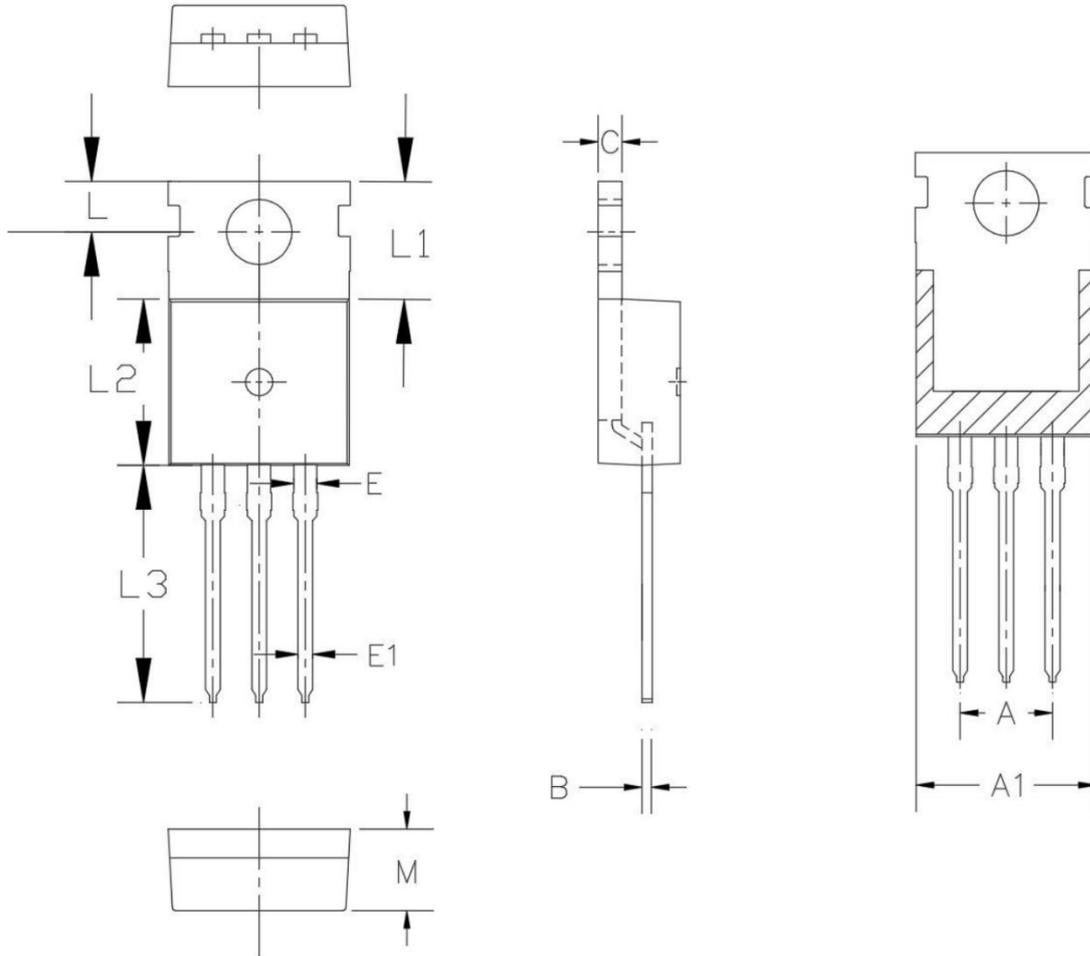
**Gate-Source Voltage vs. Gate charge**



### Safe Operating Area vs. Junction-to-Ambient



## ➤ Package Information



Symbol	MILL IMETER		
	Min	Nom	Max
A	5.08 BSC		
A1	9.00	10.00	11.00
B	0.33	--	0.65
C	1.20	--	1.40
E	1.17	--	1.37
E1	0.60	--	1.10
L	2.50	--	3.00
L1	6.3	6.5	6.7
L2	8.95	--	9.75
L3	12.88	--	13.40
M	4.30	--	4.70



## **DISCLAIMER**

SSCSEMI RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. SSCSEMI DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICIENCE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

THE GRAPHS PROVIDED IN THIS DOCUMENT ARE STATISTICAL SUMMARIES BASED ON A LIMITED NUMBER OF SAMPLES AND ARE PROVIDED FOR INFORMATIONAL PURPOSE ONLY. THE PERFORMANCE CHARACTERISTICS LISTED IN THEM ARE NOT TESTED OR GUARANTEED. IN SOME GRAPHS, THE DATA PRESENTED MAY BE OUTSIDE THE SPECIFIED OPERATING RANGE (E.G. OUTSIDE SPECIFIED POWER SUPPLY RANGE) AND THEREFORE OUTSIDE THE WARRANTED RANGE.

OUR PRODUCT SPECIFICATIONS ARE ONLY VALID IF OBTAINED THROUGH THE COMPANY'S OFFICIAL WEBSITE, CRM SYSTEM, OR OUR SALES PERSONNEL CHANNELS. IF CHANGES OR SPECIAL VERSIONS ARE INVOLVED, THEY MUST BE STAMPED WITH A QUALITY SEAL AND MARKED WITH A SPECIAL VERSION NUMBER TO BE VALID.